SHIGA7.037APC PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**Applicant** 

TAMURA, K. et al.

Appl. No.

10/560,126

Filed

August 28, 2006

For

POSITIVE RESIST

COMPOSITION, RESIST

LAMINATES AND PROCESS

FOR FORMING RESIST

**PATTERNS** 

Examiner

C. Hamilton

Group Art Unit

1752

## SECOND PRELIMINARY AMENDMENT

## Mail Stop Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## Dear Sir:

Preliminary to examination on the merits, please amend the above-referenced application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.